## 503293997 05/06/2015

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SHUNPEI YAMAZAKI	06/08/2011
JUNICHIRO SAKATA	06/15/2011
MAKOTO FURUNO	06/14/2011

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14680159

### **CORRESPONDENCE DATA**

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER: 12732-0856003

NAME OF SUBMITTER: JANELLE A. JACKSON

SIGNATURE: /Janelle A. Jackson/

DATE SIGNED: 05/06/2015

**Total Attachments: 1** 

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PATENT 503293997 REEL: 035571 FRAME: 0027

Attorney Docket No. 12732-0856003 Client Reference No. US13450-C1C1

# **ASSIGNMENT**

For valuable consideration, We, <u>Shunpei YAMAZAKI of Setagaya</u>, <u>Tokyo</u>, <u>Japan</u>, <u>Junichiro SAKATA of Atsugi</u>, <u>Kanagawa</u>, <u>Japan and Makoto FURUNO of Atsugi</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled **DEPOSITION METHOD AND METHOD FOR** MANUFACTURING SEMICONDUCTOR DEVICE, filed April 13, 2011, and assigned U.S. Serial Number 13/085,518, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature	Show remen
Name:	Shunpei YAMAZAKA
Date:	06/08/2011
Signature Name:	Junichin Sahafta  Junichiro SAKATA
Date:	06/15/20//
Signature	makoto Furuno
Name:	Makoto FURUNO
Date	06/14/2011

RECORDED: 05/06/2015

PATENT REEL: 035571 FRAME: 0028